

-	124	("tokyo electron".as. and ((cover) with (body wafer substrate))) and ((electrostatic adj chuck) chuck)	USPAT; EPO; JPO	2002/04/11 09:30
-	41	"tokyo electron".as. and ((cover) with (body wafer substrate)same chuck)	USPAT; EPO; JPO	2002/04/11 09:48
-	74	156/345.ccls. and ((cover) with (body wafer substrate)same (chuck holder susceptor))	USPAT; EPO; JPO	2002/04/11 10:22
-	1	("6221781").PN.	USPAT; EPO; JPO	2002/04/11 12:44
-	9	("4857142" "4903717" "5169408" "5194406" "5314574" "5492566" "5513668" "5762751" "5820692").PN.	USPAT	2002/04/11 10:22
-	0	6221781.URPN.	USPAT	2002/04/11 10:22
-	0	6221781.URPN.	USPAT	2002/04/11 10:22
-	0	6221781.URPN.	USPAT	2002/04/11 10:22
-	11	((("6149730") or ("5919332") or ("5868865") or ("5994251") or ("4089811") or ("5059367") or ("5384293"))).PN.	USPAT; EPO; JPO	2002/04/11 12:45
-	1	("4725467").PN.	USPAT; EPO; JPO	2002/06/13 09:47
-	2	("4678762").PN.	USPAT; EPO; JPO	2002/06/13 09:47
-	1452	361/234.ccls. 156/345.43.ccls. 156/345.34.ccls. 118/723e.ccls.	USPAT; EPO; JPO	2002/10/21 16:26
-	108	(361/234.ccls. 156/345.43.ccls. 156/345.34.ccls. 118/723e.ccls.) not @pd<=20020316	USPAT; EPO; JPO	2002/10/21 16:28
-	265	miyazaki-akira\$.in.	USPAT; EPO; JPO	2002/10/21 16:39
-	261	miyazaki-akira.in.	USPAT; EPO; JPO	2002/10/21 16:40
-	32	morita-keiji\$.in.	USPAT; EPO; JPO	2002/10/21 16:40
-	60	moriya-shuji\$.in.	USPAT; EPO; JPO	2002/10/21 16:41
-	0	nagasaka-sachiyuki\$.in	USPAT; EPO; JPO; DERWENT	2002/10/21 16:42
-	0	miyazaki-akira\$.in. and morita-keiji\$.in. and moriya-shuji\$.in.	USPAT; EPO; JPO; DERWENT	2002/10/21 16:42
-	13	miyazaki-akira\$.in. and plasma	USPAT; EPO; JPO; DERWENT	2002/10/21 16:45
-	1	morita-keiji\$.in. and plasma	USPAT; EPO; JPO; DERWENT	2002/10/21 16:45
-	8	moriya-shuji\$.in. and plasma	USPAT; EPO; JPO; DERWENT	2002/10/21 16:45
-	1	"08231266"	USPAT; EPO; JPO	2002/10/21 16:54